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Vishay/Siliconix
SUP65P04-15-E3

For any questions, you can email us directly:
sales@integrated-circuit.com

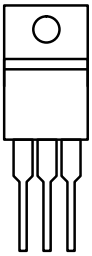
P-Channel 40 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY		
V_{DS} (V)	$R_{DS(on)}$ (Ω)	I_D (A)
- 40	0.015 at V_{GS} = - 10 V	- 65
	0.023 at V_{GS} = - 4.5 V	- 50

FEATURES

- TrenchFET® Power MOSFET
- Compliant to RoHS Directive 2002/95/EC

RoHS COMPLIANT

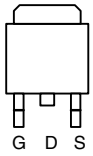


Top View

SUP65P04-15

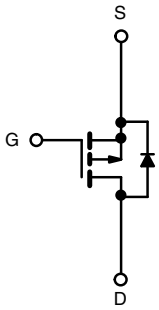
DRAIN connected to TAB

TO-263



Top View

SUB65P04-15



P-Channel MOSFET

Ordering Information: SUP65P04-15-E3 (Lead (Pb)-free)

ABSOLUTE MAXIMUM RATINGS (T_C = 25 °C, unless otherwise noted)				
Parameter		**Symbol**	**Limit**	**Unit**
Drain-Source Voltage		V_{DS}	- 40	V
Gate-Source Voltage		V_{GS}	± 20	
Continuous Drain Current (T_J = 175 °C)	T_C = 25 °C	I_D	- 65	A
	T_C = 125 °C		- 37	
Pulsed Drain Current		I_{DM}	- 240	
Avalanche Current		I_{AR}	- 60	
Repetitive Avalanche Energy[a]	L = 0.1 mH	E_{AR}	180	mJ
Power Dissipation	T_C = 25 °C (TO-220AB and TO-263)	P_D	120[c]	W
	T_A = 25 °C (TO-263)[b]		3.75	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS				
Parameter		**Symbol**	**Limit**	**Unit**
Junction-to-Ambient	PCB Mount (TO-263)[b]	R_{thJA}	40	°C/W
	Free Air (TO-220AB)	R_{thJA}	62.5	
Junction-to-Case		R_{thJC}	1.25	

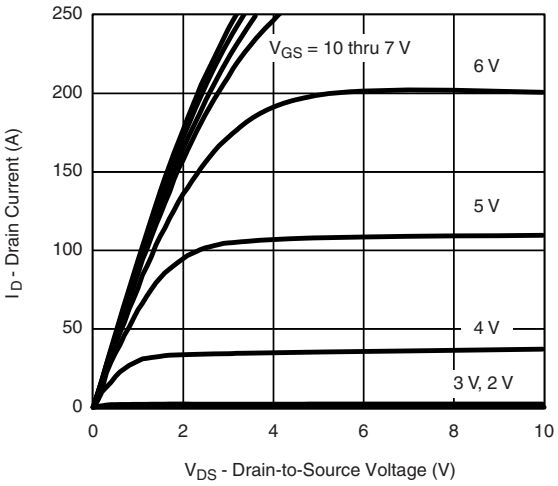
Notes:
a. Duty cycle ≤ 1 %.
b. When mounted on 1" square PCB (FR-4 material).
c. See SOA curve for voltage derating.

SPECIFICATIONS (T_J = 25 °C, unless otherwise noted)						
Parameter	**Symbol**	**Test Conditions**	**Min.**	**Typ.**	**Max.**	**Unit**
Static						
Drain-Source Breakdown Voltage	V_{DS}	V_{GS} = 0 V, I_D = - 250 µA	- 40			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = - 250 µA	- 1		- 3	
Gate-Body Leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = - 40 V, V_{GS} = 0 V			- 1	µA
		V_{DS} = - 40 V, V_{GS} = 0 V, T_J = 125 °C			- 50	
		V_{DS} = - 40 V, V_{GS} = 0 V, T_J = 175 °C			- 250	
On-State Drain Current[a]	$I_{D(on)}$	V_{DS} = - 5 V, V_{GS} = - 10 V	- 120			A
Drain-Source On-State Resistance[a]	$R_{DS(on)}$	V_{GS} = - 10 V, I_D = - 30 A		0.012	0.015	Ω
		V_{GS} = - 10 V, I_D = - 30 A, T_J = 125 °C			0.024	
		V_{GS} = - 10 V, I_D = - 30 A, T_J = 175 °C			0.030	
		V_{GS} = - 4.5 V, I_D = - 20 A		0.018	0.023	
Forward Transconductance[a]	g_{fs}	V_{DS} = - 15 V, I_D = - 50 A	20			S
Dynamic[b]						
Input Capacitance	C_{iss}	V_{GS} = 0 V, V_{DS} = - 25 V, f = 1 MHz		5400		pF
Output Capacitance	C_{oss}			640		
Reverse Transfer Capacitance	C_{rss}			300		
Total Gate Charge[c]	Q_g	V_{DS} = - 20 V, V_{GS} = - 10 V, I_D = - 65 A		85	130	nC
Gate-Source Charge[c]	Q_{gs}			25		
Gate-Drain Charge[c]	Q_{gd}			15		
Turn-On Delay Time[c]	$t_{d(on)}$	V_{DD} = - 20 V, R_L = 0.3 Ω I_D ≅ - 65 A, V_{GEN} = - 10 V, R_G = 2.5 Ω		15	25	ns
Rise Time[c]	t_r			380	580	
Turn-Off Delay Time[c]	$t_{d(off)}$			75	115	
Fall Time[c]	t_f			140	210	
Source-Drain Diode Ratings and Characteristics (T_C = 25 °C)[b]						
Continuous Current	I_S				- 65	A
Pulsed Current	I_{SM}				- 240	
Forward Voltage[a]	V_{SD}	I_F = - 65 A, V_{GS} = 0 V		- 1.2	- 1.5	V
Reverse Recovery Time	t_{rr}	I_F = - 65 A, dI/dt = 100 A/µs		40	80	ns
Peak Reverse Recovery Charge	$I_{RM(REC)}$			2	4	A
Reverse Recovery Charge	Q_{rr}			0.04	0.1	µC

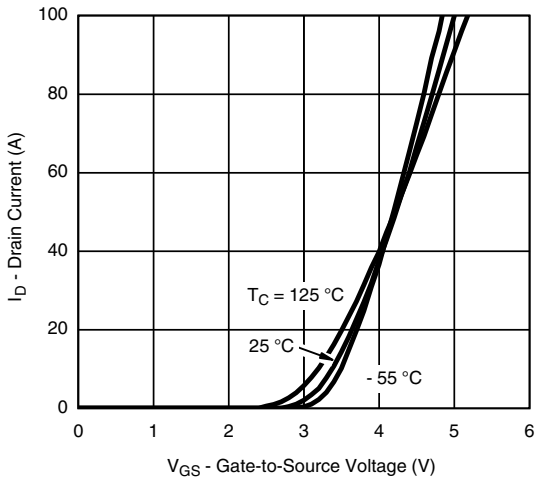
Notes:
a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %.
b. Guaranteed by design, not subject to production testing.
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

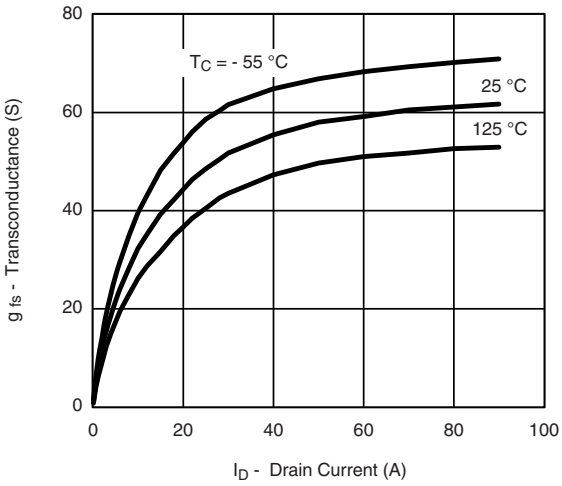
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



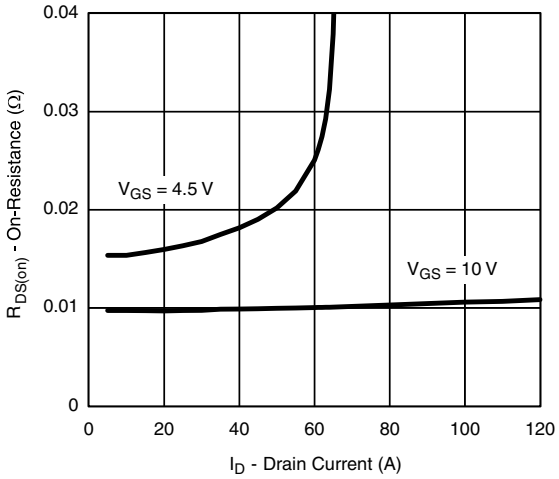
Output Characteristics



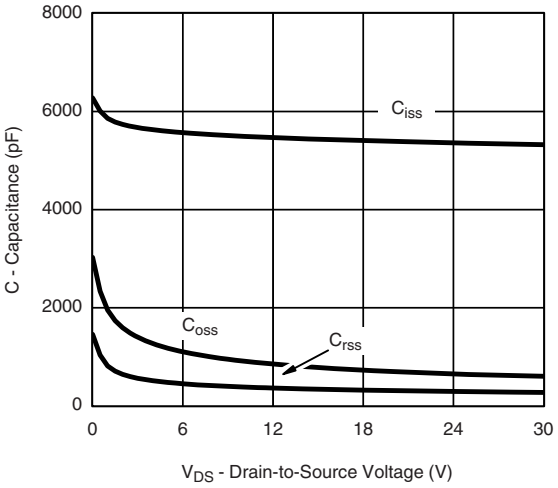
Transfer Characteristics



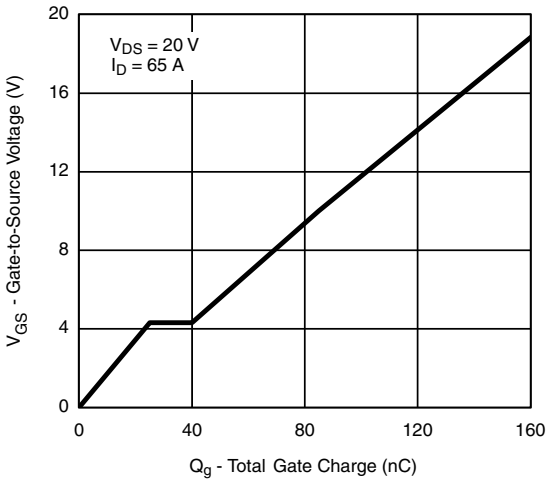
Transconductance



On-Resistance vs. Drain Current

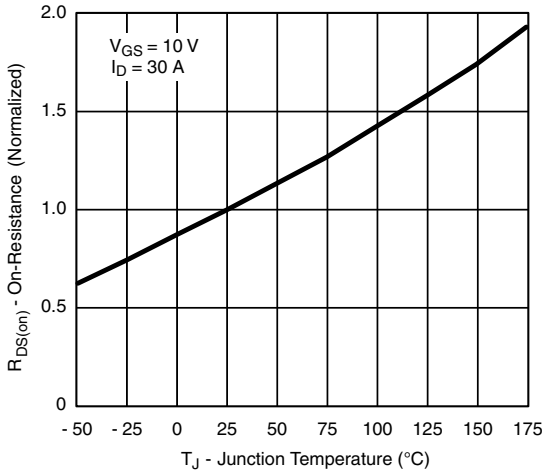


Capacitance

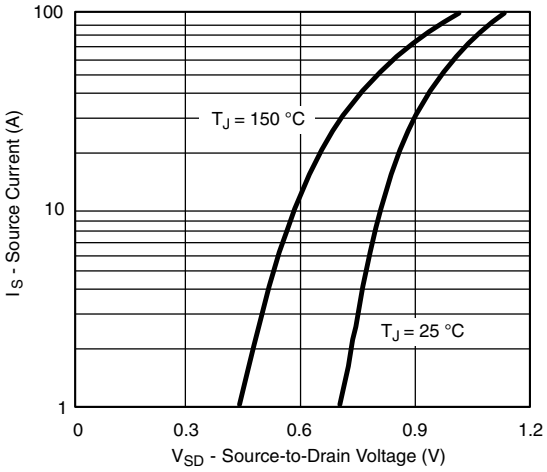


Gate Charge

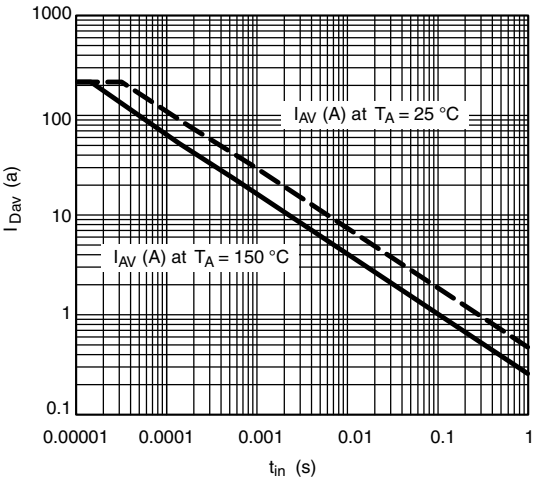
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



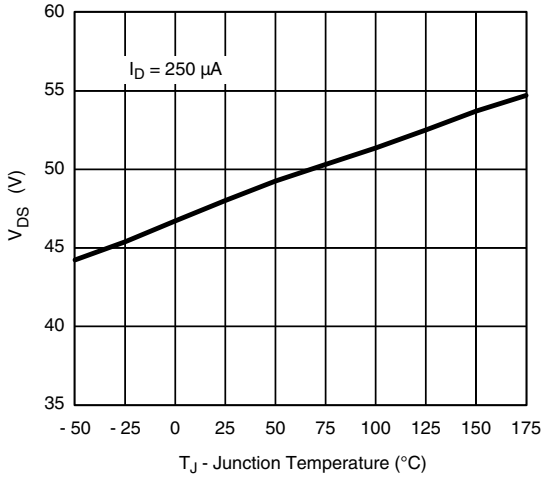
On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage

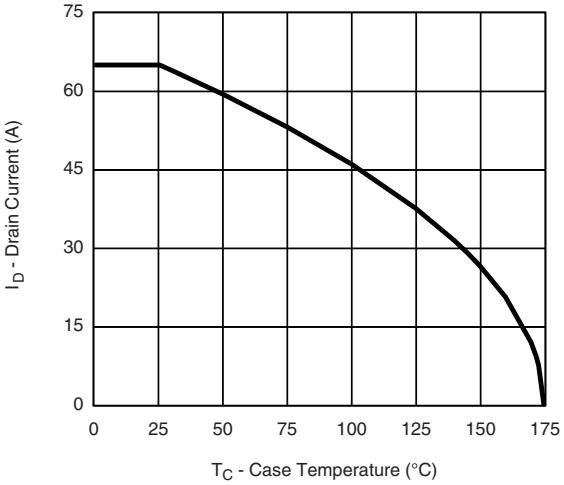


Avalanche Current vs. Time

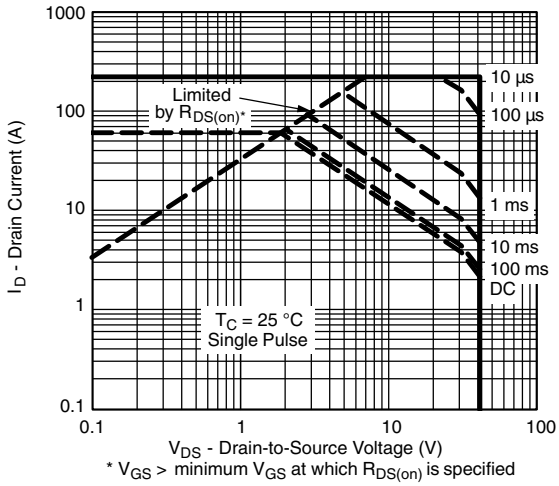


Drain Source Breakdown vs. Junction Temperature

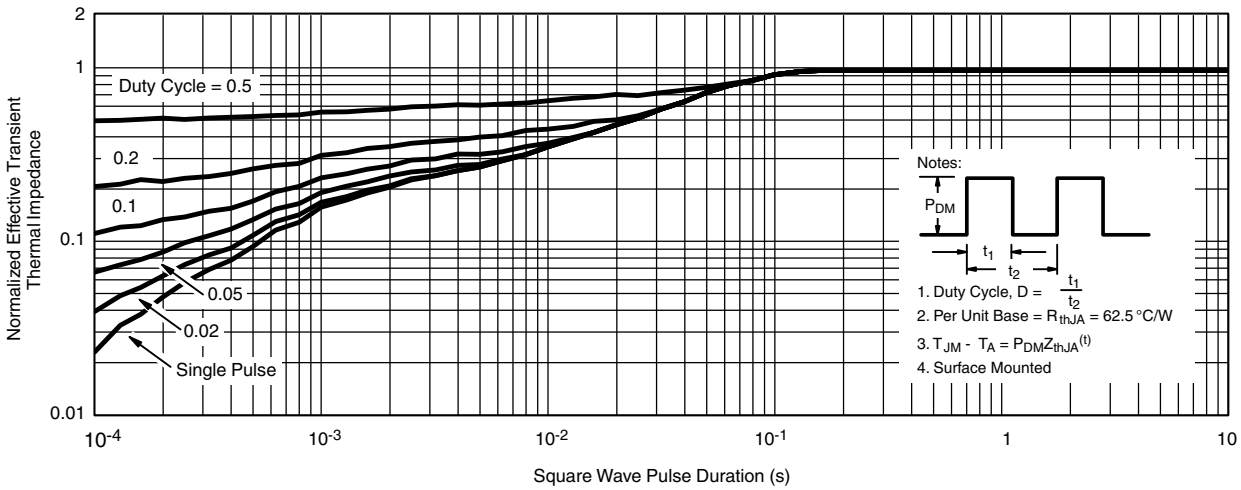
THERMAL RATINGS



Maximum Avalanche and Drain Current vs. Case Temperature



Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Case

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